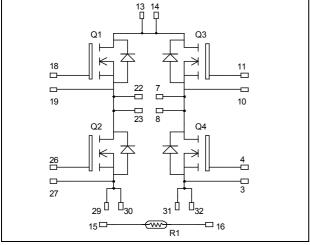


# Full - Bridge Super Junction MOSFET Power Module

$$\begin{split} V_{DSS} &= 900V \\ R_{DSon} &= 60 m\Omega \ max \ @ \ Tj = 25^{\circ}C \\ I_D &= 59A \ @ \ Tc = 25^{\circ}C \end{split}$$



## 

All multiple inputs and outputs must be shorted together Example: 13/14; 29/30; 22/23 ...

### **Application**

- Welding converters
- Switched Mode Power Supplies
- Uninterruptible Power Supplies

#### **Features**

## · COOLMOS

#### Power Semiconductors

- Ultra low R<sub>DSon</sub>
- Low Miller capacitance
- Ultra low gate charge
- Avalanche energy rated
- Very rugged
- Kelvin source for easy drive
- Very low stray inductance
  - Symmetrical design
- Internal thermistor for temperature monitoring
- High level of integration

#### **Benefits**

- Outstanding performance at high frequency operation
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Solderable terminals both for power and signal for easy PCB mounting
- Low profile
- Each leg can be easily paralleled to achieve a phase leg of twice the current capability
- RoHS Compliant

### Absolute maximum ratings

| Symbol             | Parameter   |               | Max ratings | Unit |
|--------------------|---|---------------|-------------|------|
| $V_{\mathrm{DSS}}$ | Drain - Source Breakdown Voltage                  |               | 900         | V    |
| т                  | Continuous Drain Current                          | $T_c = 25$ °C | 59          |      |
| $I_{D}$            | Continuous Diam Current                           | $T_c = 80$ °C | 44          | A    |
| $I_{DM}$           | Pulsed Drain current                              |               | 150         |      |
| $V_{GS}$           | Gate - Source Voltage                             |               | ±20         | V    |
| R <sub>DSon</sub>  | Drain - Source ON Resistance                      |               | 60          | mΩ   |
| $P_{D}$            | Maximum Power Dissipation $T_c = 25^{\circ}C$     |               | 462         | W    |
| $I_{AR}$           | Avalanche current (repetitive and non repetitive) |               | 8.8         | A    |
| E <sub>AR</sub>    | Repetitive Avalanche Energy                       |               | 2.9         | mJ   |
| $E_{AS}$           | Single Pulse Avalanche Energy                     |               | 1940        | 1113 |

CAUTION: These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on www.microsemi.com

APTC90HM60T3G-Rev 3 October, 2012



## All ratings @ $T_j = 25$ °C unless otherwise specified

### **Electrical Characteristics**

| Symbol              | Characteristic                  | Test Conditions                                   | Min | Тур  | Max | Unit |
|---------------------|---------------------------------|---|-----|------|-----|------|
| $I_{DSS}$           | Zero Gate Voltage Drain Current | $V_{GS} = 0V, V_{DS} = 900V$ $T_j = 25^{\circ}C$  |     |      | 200 | μА   |
|                     |                                 | $V_{GS} = 0V, V_{DS} = 900V$ $T_j = 125^{\circ}C$ |     | 1000 |     |      |
| R <sub>DS(on)</sub> | Drain – Source on Resistance    | $V_{GS} = 10V, I_D = 52A$                         |     | 50   | 60  | mΩ   |
| $V_{GS(th)}$        | Gate Threshold Voltage          | $V_{GS} = V_{DS}$ , $I_D = 6mA$                   | 2.5 | 3    | 3.5 | V    |
| $I_{GSS}$           | Gate – Source Leakage Current   | $V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$ |     |      | 200 | nA   |

**Dynamic Characteristics** 

| Symbol            | Characteristic            | Test Conditions  | Min | Typ  | Max | Unit |
|-------------------|---------------------------|--|-----|------|-----|------|
| $C_{iss}$         | Input Capacitance         | $V_{GS} = 0V ; V_{DS} = 100V$                                    |     | 13.6 |     | nF   |
| $C_{oss}$         | Output Capacitance        | f = 1MHz   |     | 0.66 |     | 111  |
| $Q_{g}$           | Total gate Charge         | $V_{GS} = 10V$   |     | 540  |     |      |
| $Q_{\mathrm{gs}}$ | Gate – Source Charge      | $V_{Bus} = 400V$   |     | 64   |     | nC   |
| $Q_{\mathrm{gd}}$ | Gate – Drain Charge       | $I_D = 52A$  |     | 230  |     |      |
| $T_{d(on)}$       | Turn-on Delay Time        | Inductive Switching (125°C)                                      |     | 70   |     | ns   |
| $T_{\rm r}$       | Rise Time                 | $V_{GS} = 10V$   |     | 20   |     |      |
| $T_{d(off)}$      | Turn-off Delay Time       | $V_{\text{Bus}} = 600V$ $I_{\text{D}} = 52A$                     |     | 400  |     |      |
| $T_{\mathrm{f}}$  | Fall Time                 | $R_G = 3.8\Omega$  |     | 25   |     |      |
| Eon               | Turn-on Switching Energy  | Inductive switching @ 25°C                                       |     | 3    |     | mJ   |
| $E_{\text{off}}$  | Turn-off Switching Energy | $V_{GS} = 10V ; V_{Bus} = 600V$<br>$I_D = 52A ; R_G = 3.8\Omega$ |     | 1.5  |     | IIIJ |
| Eon               | Turn-on Switching Energy  | Inductive switching @ 125°C                                      |     | 4.2  |     | T    |
| $E_{\text{off}}$  | Turn-off Switching Energy | $V_{GS} = 10V ; V_{Bus} = 600V$<br>$I_D = 52A ; R_G = 3.8\Omega$ |     | 1.7  |     | mJ   |

**Source - Drain diode ratings and characteristics** 

| Symbol           | Characteristic            | Test Conditions                     |                    | Min | Typ | Max | Unit |
|------------------|---------------------------|-------------------------------------|--------------------|-----|-----|-----|------|
| Ĭ.               | Continuous Source current |                                     | $Tc = 25^{\circ}C$ |     |     | 59  | Α    |
| $1_{\mathrm{S}}$ | (Body diode)              |                                     | $Tc = 80^{\circ}C$ |     |     | 44  | А    |
| $ m V_{SD}$      | Diode Forward Voltage     | $V_{GS} = 0V, I_S = -52A$           | L                  |     | 0.8 | 1.2 | V    |
| $t_{rr}$         | Reverse Recovery Time     | $I_S = -52A$                        | $T_j = 25$ °C      |     | 920 |     | ns   |
| Q <sub>rr</sub>  | Reverse Recovery Charge   | $V_R = 400V$ $di_S/dt = 200A/\mu s$ | $T_j = 25$ °C      |     | 60  |     | μС   |

Thermal and package characteristics

| Symbol      | Characteristic  |             | Min | Тур  | Max  | Unit |     |
|-------------|---|-------------|-----|------|------|------|-----|
| $R_{thJC}$  | Junction to Case Thermal Resistance                           |             |     |      | 0.27 | °C/W |     |
| $V_{ISOL}$  | RMS Isolation Voltage, any terminal to case t =1 min, 50/60Hz |             |     | 4000 |      |      | V   |
| $T_{J}$     | Operating junction temperature range                          |             | -40 |      | 150  |      |     |
| $T_{STG}$   | Storage Temperature Range                                     |             |     | -40  |      | 125  | °C  |
| $T_{\rm C}$ | Operating Case Temperature                                    |             |     | -40  |      | 100  |     |
| Torque      | Mounting torque   | To heatsink | M4  | 2    |      | 3    | N.m |
| Wt          | Package Weight  |             |     |      |      | 110  | g   |

APTC90HM60T3G-Rev 3 October, 2012

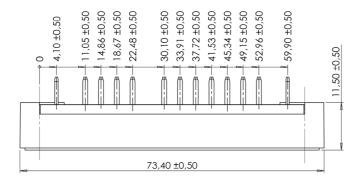


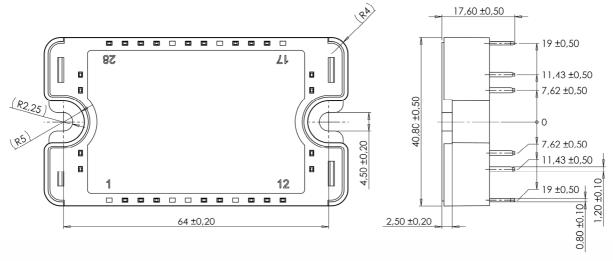
Temperature sensor NTC (see application note APT0406 on www.microsemi.com for more information).

| Symbol                 | Characteristic              |                       | Min | Тур  | Max | Unit |
|------------------------|-----------------------------|-----------------------|-----|------|-----|------|
| R <sub>25</sub>        | Resistance @ 25°C           | nce @ 25°C            |     | 50   |     | kΩ   |
| $\Delta R_{25}/R_{25}$ |                             |                       |     | 5    |     | %    |
| $B_{25/85}$            | $T_{25} = 298.15 \text{ K}$ |                       |     | 3952 |     | K    |
| $\Delta \mathrm{B/B}$  |                             | T <sub>C</sub> =100°C |     | 4    |     | %    |

$$R_T = \frac{R_{25}}{\exp \left[ B_{25/85} \left( \frac{1}{T_{25}} - \frac{1}{T} \right) \right]} \quad \text{T: Thermistor temperature}$$
 
$$R_T: \text{ Thermistor value at T}$$

### SP3 Package outline (dimensions in mm)



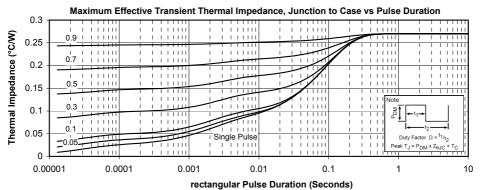


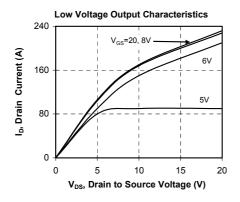
See application note 1901 - Mounting Instructions for SP3 Power Modules on www.microsemi.com

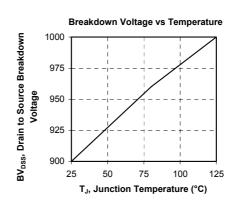
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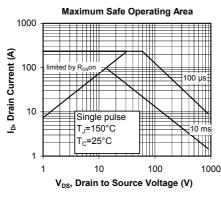


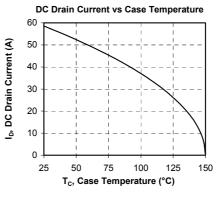
### **Typical CoolMOS Performance Curve**

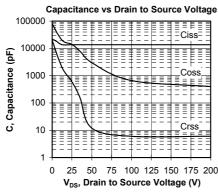


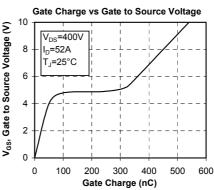








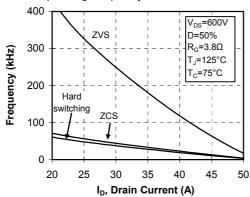


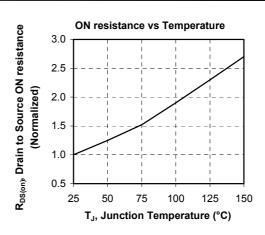


APTC90HM60T3G-Rev 3 October, 2012

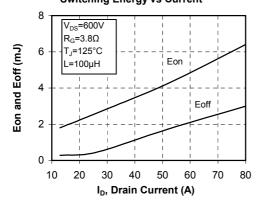


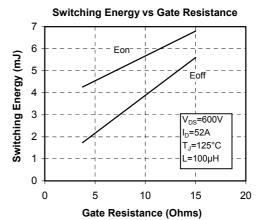
#### **Operating Frequency vs Drain Current**





### Switching Energy vs Current





"COOLMOSTM comprise a new family of transistors developed by Infineon Technologies AG. "COOLMOS" is a trademark of Infineon Technologies AG".

5 - 6



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PTC90HM60T3G-Rev 3 October, 2012